

2 3 4 78.74 42.47 42,47 P. (N. 63) 2.54 0 0 0 0 0 0 0 0 0 0 RECOMMENDED PCB LAYOUT PCB THICKNESS: 3.18mm 39.37 2.00 ± 0.05 ⊕ 0.13 A B -PAD 32 PAD I-450

2.54

CONNECTOR NOTE:

45° X I.5-

- I. HOUSING MATERIAL: HIGH TEMPERATURE THERMOPLASTIC UL 94V-O, FLAME RETARDNAT
- 2. TERMINAL: COPPER ALLOY
- 3. PLATING:

Ni: 50u"/I.27um UNDER PLATED

Au: 30u"/0.76um ON CONTACT AREA (ONE SIDE) Sn: 50u"/1.27um ON PRESS FIT TAIL

4. MANUFACTURING CODE PLEASE REFERENCE FCI SPECIFICATION GS-24-007.

25.4X3I=78.74

83.46±0.05

PCB NOTE:

5. ALL THROUGH HOLES ARE LOCATED WITH A TRUE POSITION OF 0.1mm.
6. ALL DIAMETERS ARE FINISHED HLD SIZES.
7. ØI.15Mmm DRILLED HOLES, PLATED WITH 0.007mm MIN. HASL-FREE Pb.
OVER 1.03mm TO 0.08mm Cu PLATING TO ACHIEVE A 1.02±0.07mm HOLE.

	erial code	SEE NOTE		Spec ref	* tolerance	projection	
Heattreat					180 1101		MM
Plating/Finish				ISO 1302	ISO 406	9 7	
Dr	Junon Huang	11/10/09				size A 4	Scale
Eng	Junon Huang 11/10/09 Produc			ct family		1 A4	1,500
Chr	Pei Ming Zheng	Pei Ming Zheng II/II/09 Model		Name 10075664-003		ECN	*
Appr	Joseph Hsia	11/11/09	Model	Revision	1	REL Level	CONCEPT
FCi = PRESS FIT TYPE					0 [Rev.
FSW E THESS THE TIPE			g.		10075664-003		
+ POWER EDGE CONNECTOR					бмр		" В

1.57±0.10
(PAD SURFACE)

Pro/E file catalog PDM: Rev:B

В